



ABCD Inventory for Barrel Hybrid Construction

SCT Week

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Perfect Chip Count

As of 30-Aug-03, the count of perfect ABCD chips is as follows:

Total number of Perfect Chips found at Wafer Test:	52,778
Perfect Chips in last fab lot which appears to fail X-ray QA:	308
Estimate of Chips lost due to two specific saw/pick problems:	382
Remaining Perfect Chips:	52,088
Estimate Loss Rate for Remaining Saw/Pick:	0.7%
Estimate Loss for Remaining Saw/Pick:	365
Remaining Perfect Chips Delivered for Assembly:	51,723





Chip Distribution So Far

As of 30-Aug-03, the count of perfect ABCD chips is as follows:

	From SCIPP	From RAL	From CERN	Totals
KEK - as chips	11,717	111		11,828
KEK - as wafers	1,389			1,389
Birmingham		2,757		2,757
LBNL/SCIPP	2,527			2,527
Freiburg	415			415
Hybrid SA – as wafers	2,682	1,225	3,540	7,447
Total Distributed:	18,730	18,730	18,730	18,730





1-bad-channel Count

There are 1-bad-channel chips still remaining which fall into the following two categories:

- 1 channel with analogue parameters out of spec (labeled AA1) (~15K)
- 1 channel completely dead (labeled AD1) (~23K)

These include stuck-on channels as well as stuck-off, but we do not yet know the split between the two types.





IC Allocation Plan

Mike's plan for chip allocation presented to the Steering Group is as follows:

- For Barrel:
 - ~26.7k perfect ICs
 - ~8k AA1 type ICs
 - For remaining series production, each cluster will first use up their quota (the quota = 12x number of modules to be shipped) of perfect ASICs to build modules.
 - To avoid end of batch losses the last hybrid of a lot should be completed with AA1.
 - For rework AA1 ASICs to be used
 - When the quota of perfect ASICs are exhausted, hybrids will be built with 12 AA1 ASICs/hybrid
 - All remaining AA1s and AD1 (only stuck-off) will be picked and stored in gel-packs

